

Toshiba BiCD Process Integrated Circuit Silicon Monolithic

TB67S589FNG

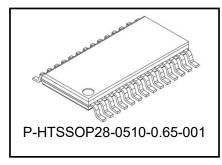
BiCD constant-current 2-phase bipolar stepping motor driver IC

1. Description

The TB67S589FNG is a PWM chopper type 2-phase bipolar drive system

stepping motor driver IC with PWM chopper type 2-phase bipolar drive. Using the BiCD process, it achieves an output withstand voltage of 50 V and a maximum current of 3.0 A.

The motor can be driven by a single VM power supply with a built-in regulator for IC operation.



Weight: 0.106 g (Typ.)

2. Features

- BiCD process integrated monolithic IC
- Bipolar stepping motor driver IC
- Advanced Current Detect System (ACDS) functionality enables PWM constant current drive without external current detection resistors
- Advanced Dynamic Mixed Decay (ADMD) function for high-efficiency PWM constant-current drive
- Clock input control
- 2-phase, 1-2 phase, W1-2 phase, 2W1-2 phase, 4W1-2 phase, 8W1-2 phase excitation available
- BiCD structure : DMOSFETs are used for output power transistors
- High withstand voltage and high current: 50 V / 3.0 A (absolute maximum rating)
- Built-in over-temperature detection (TSD), over-current detection (ISD), and low supply voltage detection (UVLO)
- Reduced external components for charge pump
- Package: P-HTSSOP28-0510-0.65-001

Start of commercial production 2023-07



3. Pin assignment

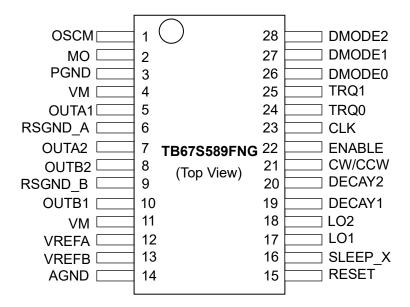


Figure 3 **Pin Assignment**



4. Block diagram

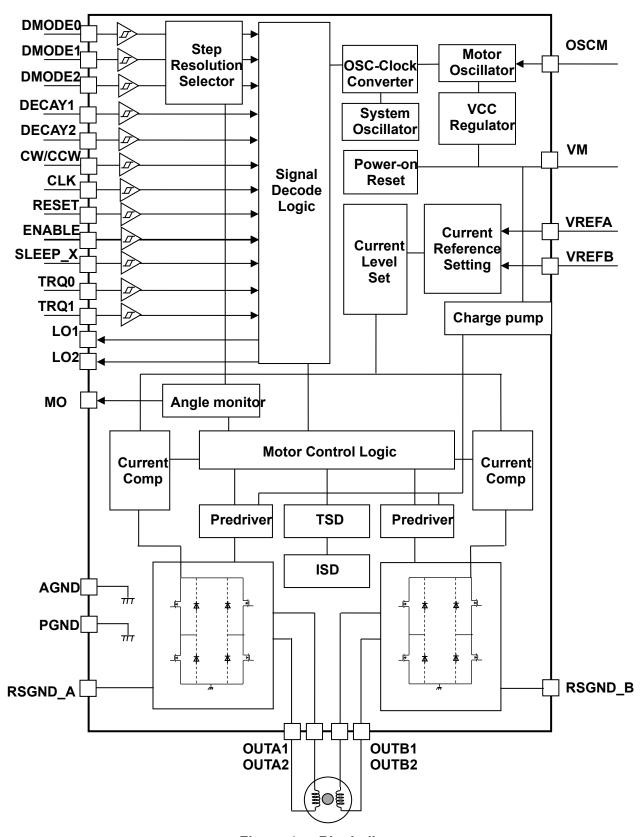


Figure 4 Block diagram

Note: Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purpose.



Note: All the grounding wires should be solid patterns and be externally terminated at only one point. Also, a grounding method should be considered for efficient heat dissipation. Careful attention should be paid to the layout of the output, VM and GND traces, to avoid short circuits across output pins or to the power supply or ground. If such a short circuit occurs, the device may be permanently damaged. Also, the utmost care should be taken for pattern designing and implementation of the device since it has power supply pins (VM, OUTA1, OUTA2, OUTB1, OUTB2, AGND, PGND, RSGND_A and RSGND_B) through which a particularly large current may run. If these pins are wired incorrectly, an operation error may occur or the device may be destroyed. The logic input pins must also be wired correctly. Otherwise, the device may be damaged owing to a current running through the IC that is larger than the specified current. Careful attention should be paid to design patterns and mounting.



5. Pin Description

Pin Description Table 5

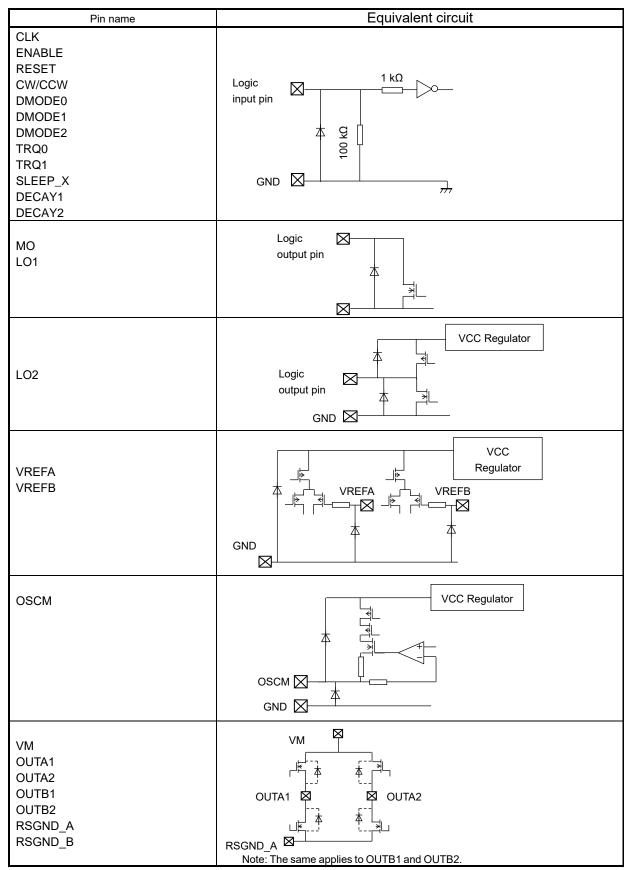
| No. | Pin name | Description | | | | | | | |
|-----|----------|--|--|--|--|--|--|--|--|
| 1 | OSCM | Resistor connection pin for setting OSCM | | | | | | | |
| 2 | МО | Electric angle monitor pin | | | | | | | |
| 3 | PGND | Motor output GND pin | | | | | | | |
| 4 | VM | VM voltage input pin | | | | | | | |
| 5 | OUT_A1 | Motor phase-A output pin | | | | | | | |
| 6 | RSGND_A | Motor phase-A GND pin | | | | | | | |
| 7 | OUT_A2 | Motor phase-A output pin | | | | | | | |
| 8 | OUT_B2 | Motor phase-B output pin | | | | | | | |
| 9 | RSGND_B | Motor phase B GND pin | | | | | | | |
| 10 | OUT_B1 | Notor phase B output pin | | | | | | | |
| 11 | VM | VM voltage input pin | | | | | | | |
| 12 | VREF_A | Reference power supply pin for setting current value of phase A output | | | | | | | |
| 13 | VREF_B | Reference power supply pin for setting the current value of phase B output | | | | | | | |
| 14 | AGND | GND pin | | | | | | | |
| 15 | RESET | RESET signal input pin. Initializes the electric angle. | | | | | | | |
| 16 | SLEEP_X | SLEEP signal input pin. | | | | | | | |
| 17 | LO1 | Reset signal output pin when abnormality is detected. | | | | | | | |
| 18 | LO2 | Reset signal output pin for abnormality detection. | | | | | | | |
| 19 | DECAY1 | Constant current chopping control switching pin | | | | | | | |
| 20 | DECAY2 | Constant current chopping control switching pin. | | | | | | | |
| 21 | CW_CCW | Rotation direction switching pin | | | | | | | |
| 22 | ENABLE | ENABLE signal input pin to control output ON/OFF of phase A and B. | | | | | | | |
| 23 | CLK | Clock signal input pin. The rising edge advances the electric angle. | | | | | | | |
| 24 | TRQ0 | Torque switching pin. | | | | | | | |
| 25 | TRQ1 | Torque switching pin. | | | | | | | |
| 26 | DMODE0 | Excitation mode setting pin | | | | | | | |
| 27 | DMODE1 | Excitation mode setting pin | | | | | | | |
| 28 | DMODE2 | Excitation mode setting pin | | | | | | | |

Note: NC pin should be opened.



6. Input / Output Equivalent Circuit

Table 6 Input / Output Equivalent Circuit



Note: The equivalent circuit diagrams may be simplified for explanatory purposes.



7. Functional Description

7.1. Function of SLEEP X

The output can be recovered from the forced OFF state due to the operation of the thermal shutdown circuit (TSD)/overcurrent detection circuit (ISD) by setting the device to sleep mode once and then setting it to normal operation mode again. High is input, the device returns to normal operation in 10 ms (max.)

Table 7.1 Function of SLEEP_X

| SLEEP_X | Function |
|---------|--|
| L | Power saving mode (charge pump stopped, VCC Reg stopped) |
| Н | normal operation |

7.2. Function of CLK

Each CLK advances the electric angle by one, and the signal is reflected on the Up edge.

Table 7.2 Function of CLK

| CLK | Function |
|----------|------------------------------------|
| ↑ | Take the next step with an up-edge |
| \ | -(Hold previous state) |

7.3. Function of ENABLE

Switches stepping motor drive ON/OFF. Turning the motor drive ON starts normal constant current control, and setting it to OFF turns the MOSFET OFF and the output is high impedance.

Table 7.3 Function of ENABLE

| ENABLE | Function |
|--------|---|
| Н | Output MOSFET operation : ON (normal operation) |
| L | Output MOSFET operation : OFF (operation stopped, high impedance) |

7.4. Function of CW/CCW

Switches the direction of rotation of the stepping motor.

Table7.4 Function of CW/CCW

| CW/CCW | Function |
|--------|---------------|
| Н | Forward(CW) |
| L | Reverse (CCW) |



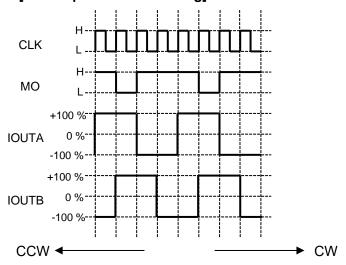
7.5. Function of DMODE0, DMODE1, DMODE2

Switches step resolution.

Table 7.5 Function of DMODE 0, DMODE 1, DMODE 2

| DMODE0 | DMODE1 | DMODE2 | Function |
|--------|--------|--------|----------------------------------|
| L | L | L | Full step resolution setting |
| L | L | Н | Half step resolution (a) setting |
| L | Н | L | Half step resolution (b) setting |
| L | Н | Н | Quarter step resolution setting |
| Н | L | Г | 1/8 step resolution setting |
| Н | L | Н | 1/16 step resolution setting |
| Н | Н | Г | 1/32 step resolution setting |
| Н | Н | Н | 1/32 step resolution setting |

7.6. Sequence by drive mode in clock input control mode [Full step resolution setting]



Full step resolution setting figure7.6.1

[Half step resolution (a) setting] CLK MO +100 % 0 % **IOUTA** -100 % +100 % **IOUTB** 0 % -100 %-CCW ◀ CW

Figure 7.6.2 Half step resolution (a) setting

MO output is the terminal waveform in Pull Up state. Note: The timing chart is simplified to explain the function and operation.



[Half step resolution (b) setting]

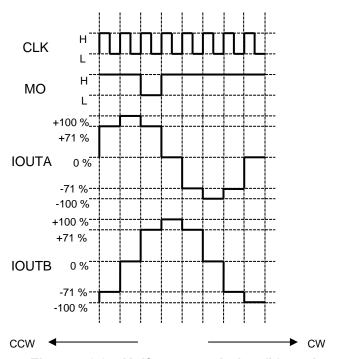


Figure 7.6.3 Half step resolution (b) setting

[Quarter step resolution setting]

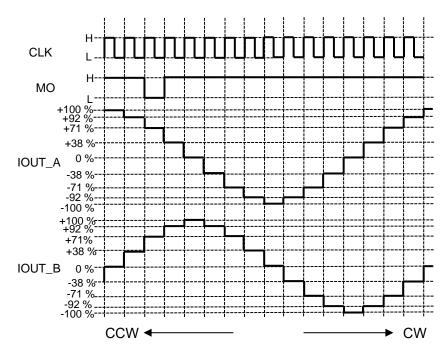


Figure 7.6.4 Quarter step resolution setting

MO output is the pin waveform in Pull Up state.

Note: The timing chart is simplified to explain the function and operation.



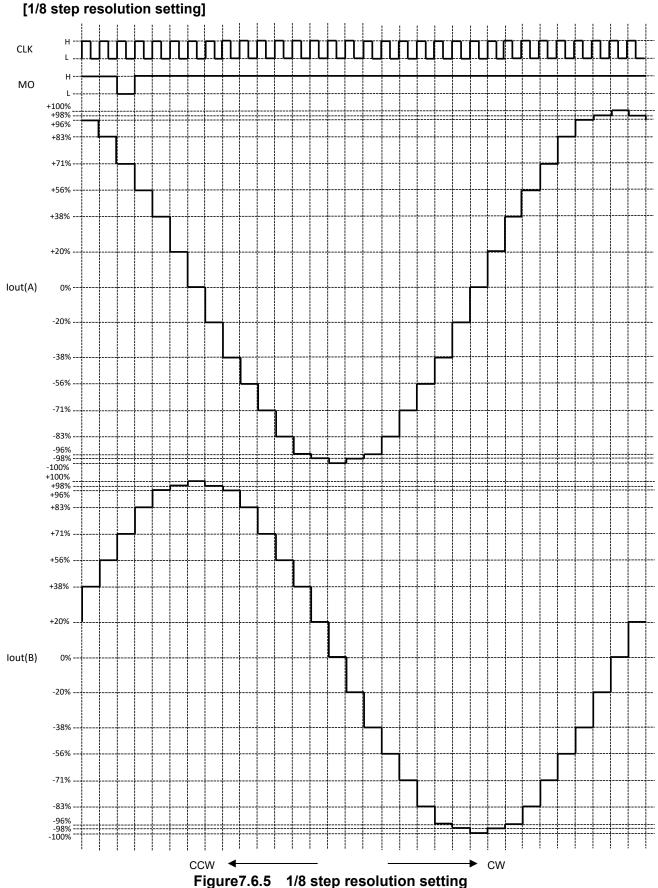


Figure 7.6.5 1/8 step resolution setting

MO output is the pin waveform in Pull Up state.

Note: The timing chart is simplified to explain the function and operation.

[1/16 step resolution setting]



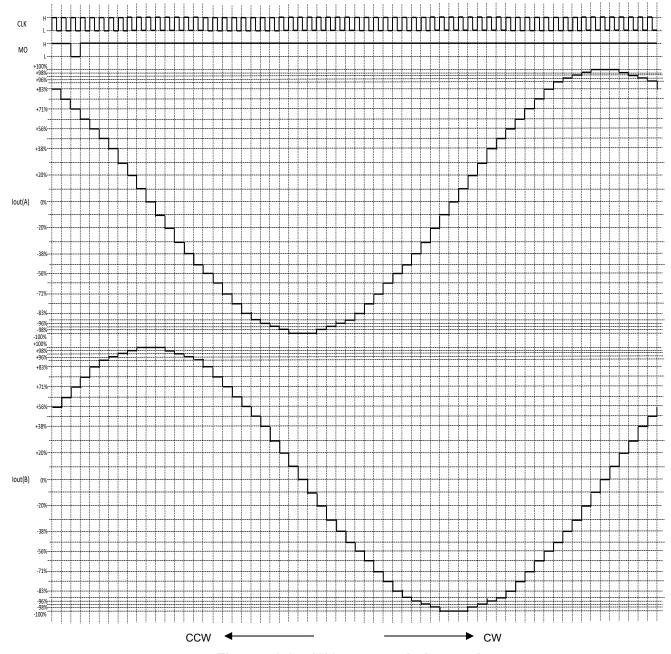


Figure 7.6.6 1/16 step resolution setting

MO output is the pin waveform in Pull Up state.

Note: The timing chart is simplified to explain the function and operation.



[1/32 step resolution setting]

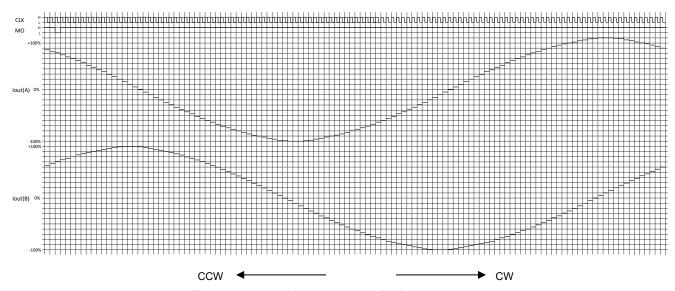


Figure 7.6.7 1/32 step resolution setting

MO output is the pin waveform in Pull Up state.

Note: The timing chart is simplified to explain the function and operation.



7.7. Excitation method and set current value

Refer to the table below for Step current for each excitation. The table is for the case where CW_CCW=High setting.

Table 7.7 Excitation method and set current value

| STEP | 1/: | 32 | 1/ | 16 | 1, | /8 | 1, | /4 | 1/2 | 2(b) | 1/2 | 2(a) | F | ull |
|------|------------|----------|------------|----------|------------|----------|------------|----------|------------|----------|------------|----------|-----|-----|
| _ | Ach | Bch | Ach | Bch |
| θ0 | (%) 100 | (%) 0 | (%) | (%) |
| θ1 | 100 | 5 | | | | | | | | | | | | |
| θ2 | 100 | 10 | 100 | 10 | | | | | | | | | | |
| θ3 | 99 | 15 | | | | | | | | | | | | |
| θ4 | 98 | 20 | 98 | 20 | 98 | 20 | | | | | | | | |
| θ5 | 97 | 24 | | | | | | | | | | | | |
| θ6 | 96 | 29 | 96 | 29 | | | | | | | | | | |
| θ7 | 94 | 34 | | | | | | | | | | | | |
| 98 | 92 | 38 | 92 | 38 | 92 | 38 | 92 | 38 | | | | | | |
| 09 | 90 | 43 | | | | | | | | | | | | |
| θ10 | 88 | 47 | 88 | 47 | | | | | | | | | | |
| θ11 | 86 | 51 | | | | | | | | | | | | |
| θ12 | 83 | 56 | 83 | 56 | 83 | 56 | | | | | | | | |
| θ13 | 80 | 60 | | | | | | | | | | | | |
| θ14 | 77 | 63 | 77 | 63 | | | | | | | | | | |
| θ15 | 74 | 67 | | | | | | | | | | | | |
| θ16 | 71 | 71 | 71 | 71 | 71 | 71 | 71 | 71 | 71 | 71 | 100 | 100 | 100 | 100 |
| θ17 | 67 | 74 | | | | | | | | | | | | |
| θ18 | 63 | 77 | 63 | 77 | | | | | | | | | | |
| θ19 | 60 | 80 | | | | | | | | | | | | |
| θ20 | 56 | 83 | 56 | 83 | 56 | 83 | | | | | | | | |
| θ21 | 51 | 86 | | | | | | | | | | | | |
| θ22 | 47 | 88 | 47 | 88 | | | | | | | | | | |
| θ23 | 43 | 90 | | | | | | | | | | | | |
| θ24 | 38 | 92 | 38 | 92 | 38 | 92 | 38 | 92 | | | | | | |
| θ25 | 34 | 94 | | | | | | | | | | | | |
| θ26 | 29 | 96 | 29 | 96 | | | | | | | | | | |
| θ27 | 24 | 97 | | | | | | | | | | | | |
| θ28 | 20 | 98 | 20 | 98 | 20 | 98 | | | | | | | | |
| θ29 | 15 | 99 | | | | | | | | | | | | |
| θ30 | 10 | 100 | 10 | 100 | | | | | | | | | | |
| θ31 | 5 | 100 | | | | | | | | | | | | |
| θ32 | 0 | 100 | 0 | 100 | 0 | 100 | 0 | 100 | 0 | 100 | 0 | 100 | | |



| STEP | | | | | | | | | | | | | | וטטו | 330 |
|--|------|------|-----|------|-----|------|-----|------|-----|------|------|------|------|------|-----|
| | STEP | 1/3 | 32 | 1/ | 16 | 1. | /8 | 1, | /4 | 1/2 | 2(b) | 1/2 | 2(a) | F | ull |
| 833 -5 100 | _ | | | | | | | | | | | | | | |
| 0.54 | | | | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) |
| 0.95 | | | | | | | | | | | | | | | |
| 036 | θ34 | -10 | 100 | -10 | 100 | | | | | | | | | | |
| 837 -24 97 88 -29 96 -29 96 -89 | θ35 | -15 | 99 | | | | | | | | | | | | |
| 038 -29 96 -29 96 -29 96 -29 96 -29 96 -29 96 -29 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 92 -38 -3 | θ36 | -20 | 98 | -20 | 98 | -20 | 98 | | | | | | | | |
| 039 | θ37 | -24 | 97 | | | | | | | | | | | | |
| 040 -38 92 -38 -8 -38 -38 -39 | θ38 | -29 | 96 | -29 | 96 | | | | | | | | | | |
| 941 -43 90 - <td>θ39</td> <td>-34</td> <td>94</td> <td></td> | θ39 | -34 | 94 | | | | | | | | | | | | |
| 942 -47 88 -47 88 -47 88 -47 88 -47 88 -47 88 -47 88 -47 88 -47 88 -47 88 -47 88 -47 88 -47 88 -47 88 -47 -48 -47 88 -48 -47 -48 -47 -68 83 -56 83 -56 83 -60 -48 -60 -63 77 -63 77 -71 71 -71 | θ40 | -38 | 92 | -38 | 92 | -38 | 92 | -38 | 92 | | | | | | |
| 943 -51 86 83 -56 83 -56 83 -60 80 -60 80 -60 80 -60 80 -60 80 -60 80 -60 80 -60 -60 -63 77 -63 77 -63 77 -63 77 -71 71 -71 | θ41 | -43 | 90 | | | | | | | | | | | | |
| 943 -51 86 83 -56 83 -56 83 -60 80 -60 80 -60 80 -60 80 -60 80 -60 80 -60 80 -60 -63 77 -63 77 -63 77 -63 77 -63 77 -71 71 | θ42 | -47 | 88 | -47 | 88 | | | | | | | | | | |
| 945 -60 80 -63 77 -63 77 -63 77 -63 77 -63 77 -63 77 -63 77 -63 77 -63 -74 -67 -74 -71 | θ43 | -51 | 86 | | | | | | | | | | | | |
| 946 -63 77 -63 77 -63 77 -63 77 -63 77 -63 77 -71 | 044 | -56 | 83 | -56 | 83 | -56 | 83 | | | | | | | | |
| 946 -63 77 -63 77 -63 77 -63 77 -63 77 -63 77 -71 | 045 | -60 | 80 | | | | | | | | | | | | |
| 947 -67 74 | 946 | -63 | | -63 | 77 | | | | | | | | | | |
| 848 -71 71 -71 | 047 | -67 | 74 | | | | | | | | | | | | |
| 049 -74 67 63 -77 63 -77 63 -80 60 -83 56 -83 59 -83 -92 38 -92 38 -92 38 -92 38 -92 38 -92 38 | | -71 | 71 | -71 | 71 | -71 | 71 | -71 | 71 | -71 | 71 | -100 | 100 | -100 | 100 |
| 050 -77 63 -77 63 -80 -90 -80 -90 | | | | | | | | | | | | | | | |
| 951 -80 60 952 -83 56 -83 56 953 -86 51 954 -88 47 -88 47 955 -90 43 -92 38 -92 38 956 -92 38 -92 38 -92 38 957 -94 34 -94 34 -94 34 -94 34 -94 34 -94 34 -94 | | | | -77 | 63 | | | | | | | | | | |
| 052 -83 56 -83 -82 -83 -82 -83 -92 -83 -92 -83 -92 -92 -92 -92 -92 -93 -92 -93 -92 38 -92 38 -92 38 -92 38 -92 38 -92 38 -92 38 -92 38 -92 38 -92 38 -92 38 -92 -92 -93 -92 -93 -92 -93 -92 -93 -92 | | | | | | | | | | | | | | | |
| 953 -86 51 954 -88 47 47 47 48 47 47 48 47 47 48 47 47 48 47 47 48 47 48 47 48 47 48 47 48 47 48 47 48 47 48 47 48 47 48 47 48 48 48 48 48 47 48 | | | | -83 | 56 | -83 | 56 | | | | | | | | |
| 954 -88 47 -88 47 955 -90 43 -92 38 -92 38 -92 38 956 -92 38 -92 38 -92 38 -92 38 957 -94 34 -92 38 | | | | | | | | | | | | | | | |
| 955 -90 43 <td></td> <td></td> <td></td> <td>-88</td> <td>47</td> <td></td> | | | | -88 | 47 | | | | | | | | | | |
| 956 -92 38 -92 38 -92 38 957 -94 34 | | | | - 00 | 7, | | | | | | | | | | |
| 957 -94 34 < | | | | 02 | 20 | 02 | 20 | 02 | 20 | | | | | | |
| 958 -96 29 -96 29 959 -97 24 -98 20 -98 20 960 -98 20 -98 20 -98 20 961 -99 15 -98 20 | | | | -92 | 30 | -92 | 30 | -92 | 30 | | | | | | |
| 059 -97 24 | | | | 00 | 20 | | | | | | | | | | |
| 960 -98 20 -98 20 961 -99 15 962 -100 10 -100 10 963 -100 5 | | | | -90 | 29 | | | | | | | | | | |
| 961 -99 15 962 -100 10 -100 10 963 -100 5 | | | | 00 | 00 | 00 | 00 | | | | | | | | |
| 962 -100 10 -100 10 963 -100 5 | | | | -98 | 20 | -98 | 20 | | | | | | | | |
| 963 -100 5 | | | | | | | | | | | | | | | |
| | | | | -100 | 10 | | | | | | | | | | |
| | | | | | | | | | | | | | | | |
| | θ64 | -100 | 0 | -100 | 0 | -100 | 0 | -100 | 0 | -100 | 0 | -100 | 0 | | |
| 965 -100 -5 | θ65 | -100 | -5 | | | | | | | | | | | | |
| 966 -100 -10 -100 -10 | 966 | -100 | -10 | -100 | -10 | | | | | | | | | | |
| 967 -99 -15 | θ67 | -99 | -15 | | | | | | | | | | | | |
| 968 -98 -20 -98 -20 -98 -20 | 968 | -98 | -20 | -98 | -20 | -98 | -20 | | | | | | | | |



| | | | | | | | | | | | | | וטטו | 330 |
|------|------------|------------|-----|------|-----|------|-----|------|-----|------|------|------|------|------|
| STEP | 1/ | 32 | 1/ | 16 | 1 | /8 | 1. | /4 | 1/2 | 2(b) | 1/2 | 2(a) | F | ull |
| | Ach | Bch | Ach | Bch | Ach | Bch | Ach | Bch | Ach | Bch | Ach | Bch | Ach | Bch |
| 069 | (%) -97 | (%) -24 | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) |
| | | | 06 | 20 | | | | | | | | | | |
| θ70 | -96 | -29 | -96 | -29 | | | | | | | | | | |
| θ71 | -94 | -34 | | | | | | | | | | | | |
| θ72 | -92 | -38 | -92 | -38 | -92 | -38 | -92 | -38 | | | | | | |
| θ73 | -90 | -43 | | | | | | | | | | | | |
| θ74 | -88 | -47 | -88 | -47 | | | | | | | | | | |
| θ75 | -86 | -51 | | | | | | | | | | | | |
| θ76 | -83 | -56 | -83 | -56 | -83 | -56 | | | | | | | | |
| θ77 | -80 | -60 | | | | | | | | | | | | |
| θ78 | -77 | -63 | -77 | -63 | | | | | | | | | | |
| θ79 | -74 | -67 | | | | | | | | | | | | |
| 080 | -71 | -71 | -71 | -71 | -71 | -71 | -71 | -71 | -71 | -71 | -100 | -100 | -100 | -100 |
| θ81 | -67 | -74 | | | | | | | | | | | | |
| θ82 | -63 | -77 | -63 | -77 | | | | | | | | | | |
| θ83 | -60 | -80 | | | | | | | | | | | | |
| θ84 | -56 | -83 | -56 | -83 | -56 | -83 | | | | | | | | |
| θ85 | -51 | -86 | | | | | | | | | | | | |
| θ86 | -47 | -88 | -47 | -88 | | | | | | | | | | |
| θ87 | -43 | -90 | | | | | | | | | | | | |
| θ88 | -38 | -92 | -38 | -92 | -38 | -92 | -38 | -92 | | | | | | |
| θ89 | -34 | -94 | | | | | | | | | | | | |
| 090 | -29 | -96 | -29 | -96 | | | | | | | | | | |
| θ91 | -24 | -97 | | | | | | | | | | | | |
| θ92 | -20 | -98 | -20 | -98 | -20 | -98 | | | | | | | | |
| θ93 | -15 | -99 | | | | | | | | | | | | |
| θ94 | -10 | -100 | -10 | -100 | | | | | | | | | | |
| θ95 | -5 | -100 | | | | | | | | | | | | |
| θ96 | 0 | -100 | 0 | -100 | 0 | -100 | 0 | -100 | 0 | -100 | 0 | -100 | | |
| θ97 | 5 | -100 | | | | | | | | | | | | |
| θ98 | 10 | -100 | 10 | -100 | | | | | | | | | | |
| θ99 | 15 | -99 | | | | | | | | | | | | |
| θ100 | 20 | -98 | 20 | -98 | 20 | -98 | | | | | | | | |
| θ101 | 24 | -97 | | | | | | | | | | | | |
| θ102 | 29 | -96 | 29 | -96 | | | | | | | | | | |
| θ103 | 34 | -94 | | | | | | | | | | | | |
| θ104 | 38 | -92 | 38 | -92 | 38 | -92 | 38 | -92 | | | | | | |
| 0104 | 50 | -92 | 50 | -32 | 50 | .92 | 50 | -92 | | | | | | |



| STEP | 1/: | 32 | 1/ | 16 | 1, | /8 | 1, | /4 | 1/2 | 2(b) | 1/2 | 2(a) | F | ull |
|------|-----|-----|-----|-----|-----|-----|-----|-----|-----|------|-----|------|-----|------|
| | Ach | Bch | Ach | Bch | Ach | Bch |
| | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) | (%) |
| θ105 | 43 | -90 | | | | | | | | | | | | |
| θ106 | 47 | -88 | 47 | -88 | | | | | | | | | | |
| θ107 | 51 | -86 | | | | | | | | | | | | |
| θ108 | 56 | -83 | 56 | -83 | 56 | -83 | | | | | | | | |
| θ109 | 60 | -80 | | | | | | | | | | | | |
| θ110 | 63 | -77 | 63 | -77 | | | | | | | | | | |
| θ111 | 67 | -74 | | | | | | | | | | | | |
| θ112 | 71 | -71 | 71 | -71 | 71 | -71 | 71 | -71 | 71 | -71 | 100 | -100 | 100 | -100 |
| θ113 | 74 | -67 | | | | | | | | | | | | |
| θ114 | 77 | -63 | 77 | -63 | | | | | | | | | | |
| θ115 | 80 | -60 | | | | | | | | | | | | |
| θ116 | 83 | -56 | 83 | -56 | 83 | -56 | | | | | | | | |
| θ117 | 86 | -51 | | | | | | | | | | | | |
| θ118 | 88 | -47 | 88 | -47 | | | | | | | | | | |
| θ119 | 90 | -43 | | | | | | | | | | | | |
| θ120 | 92 | -38 | 92 | -38 | 92 | -38 | 92 | -38 | | | | | | |
| θ121 | 94 | -34 | | | | | | | | | | | | |
| θ122 | 96 | -29 | 96 | -29 | | | | | | | | | | |
| θ123 | 97 | -24 | | | | | | | | | | | | |
| θ124 | 98 | -20 | 98 | -20 | 98 | -20 | | | | | | | | |
| θ125 | 99 | -15 | | | | | | | | | | | | |
| θ126 | 100 | -10 | 100 | -10 | | | | | | | | | | |
| θ127 | 100 | -5 | | | | | | | | | | | | |
| θ128 | 100 | 0 | 100 | 0 | 100 | 0 | 100 | 0 | 100 | 0 | 100 | 0 | | |



7.8. Selectable Mixed Decay Function

Selectable Mixed Decay is a function that allows the amount of current regeneration during the current regeneration (decay) period to be adjusted by the DECAY pin.

Mixed Decay control itself is achieved by switching between the three control modes of Chage, Slow, and Fast, and the DECAY pin allows this constant-current control to be selected from among four settings. If this setting is switched during constant current operation, the new setting will be applied from the next chopping cycle.

| DECAY2 | DECAY1 | Function | | | | |
|--------|--------|-----------------|--|--|--|--|
| L | L | Mixed Decay | | | | |
| L | Н | Slow Decay only | | | | |
| Н | L | Fast Decay only | | | | |
| Н | Н | ADMD | | | | |

Table7.8 Selectable Mixed Decay Function

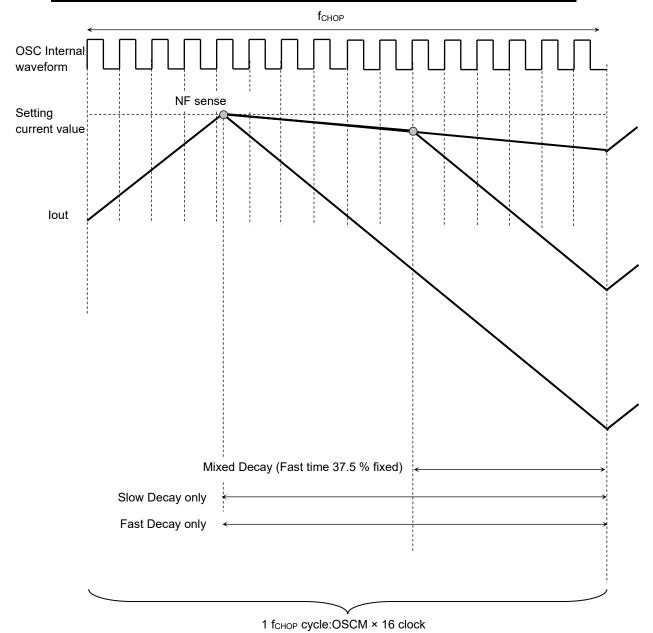


Figure 7.8 Selectable Mixed Decay Function

Note: Timing charts are simplified to illustrate functions and operations.



7.9. Mixed Decay current waveform 1

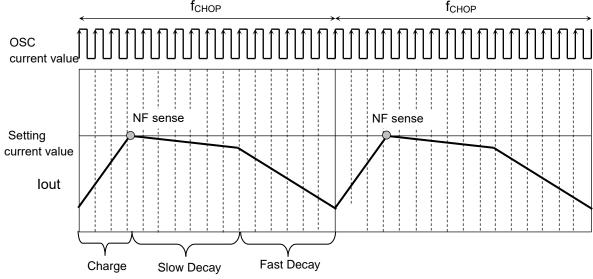


Figure 7.9 Mixed Decay waveform

Note: Timing charts are simplified to illustrate functions and operations.

7.10. For each time of constant-current PWM operation

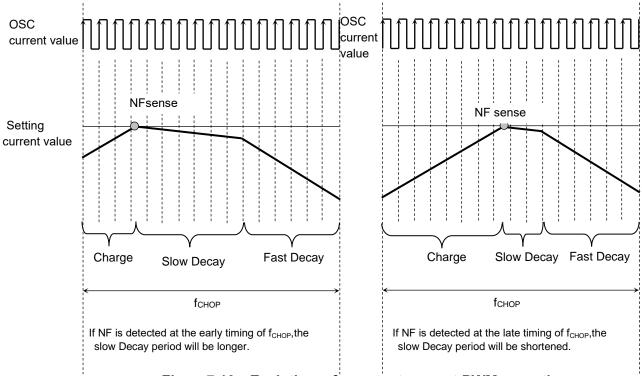


Figure 7.10 Each time of constant-current PWM operation

The time required for the current flowing in the motor to reach the set current value (charge period) varies depending on the drive conditions.

The timing of NF detection (motor current reaching the set current value) during the mixed decay chopping cycle (f_{CHOP}) varies from time to time. As shown in the example above, if NF is detected at a relatively early timing, the Slow Decay period will be longer, and if it is detected later, the Slow Decay period will be shorter.

Note: Basically, f_{CHOP} time - (Charge + Fast decay time) = Slow decay time.

(Fast decay time is fixed at 37.5 % (OSCM: 6 CLK minutes).

Note: Timing chart is simplified to explain functions and operations.



7.11. Mixed Decay current waveform 2

• If the set current value is in the increasing direction

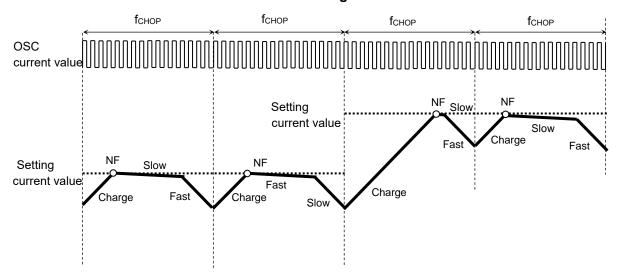


Figure 7.11.1 If the set current value is in the increasing direction

• If the Charge period is more than one fCHOP cycle

If the period of time (Charge period) until the motor current reaches the next set value (step), such as when switching the set current value (step), exceeds one cycle of the set chopping cycle (f_{CHOP}), Charge continues for the next f_{CHOP} cycle, and after reaching NF, the motor transitions to Mixed Decay control.

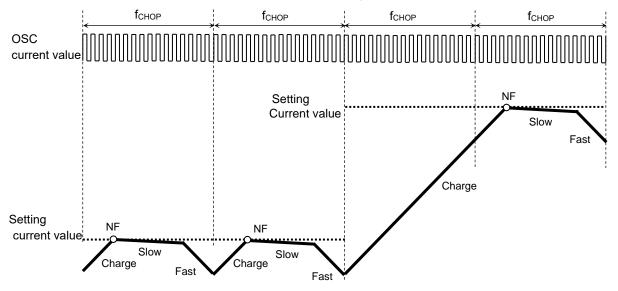


Figure 7.11.2 If the Charge period is more than one f_{CHOP} cycle



If the set current value is in the decreasing direction

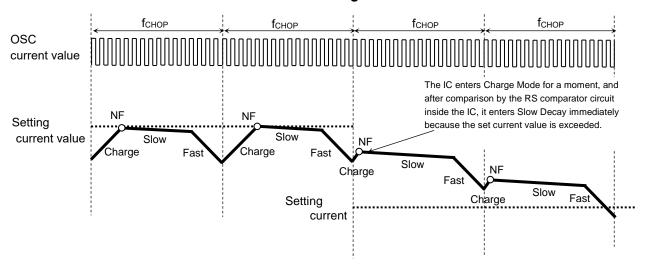


Figure 7.11.3 If the set current value is in the decreasing direction

Note: Timing charts are simplified to explain functions and operations.



7.12. ADMD (Advanced Dynamic Mixed Decay) Constant current control

ADMD monitors both the current flowing from the power supply to the motor and the current regenerated from the motor to the power supply, and performs constant-current PWM control. The basic sequence of ADMD is as follows

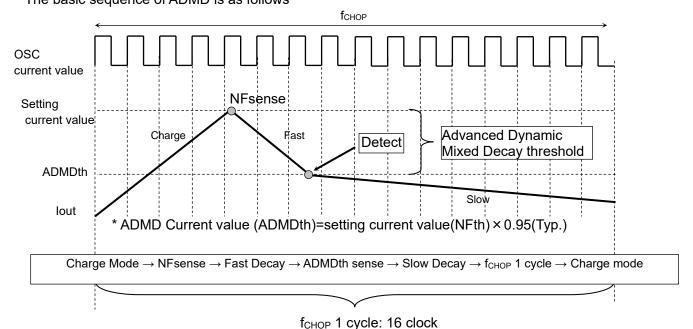


Figure 7.12.1 ADMD (Advanced Dynamic Mixed Decay) Constant current control 1

Note: Timing charts are simplified to explain functions and operations. Values in the timing chart are for reference only.

Various filters are set as follows to prevent current mis-detection due to external noise jumps, etc. If the L value of the motor used is small and the current value reaches ADMDth (ADMD current value) within the ADMDtblank period, the motor switches to Slow operation after the ADMDtblank period. In this case, the ADMD current value (ADMDth) is smaller than the set current value (NFth) x 0.95 (Typ.).

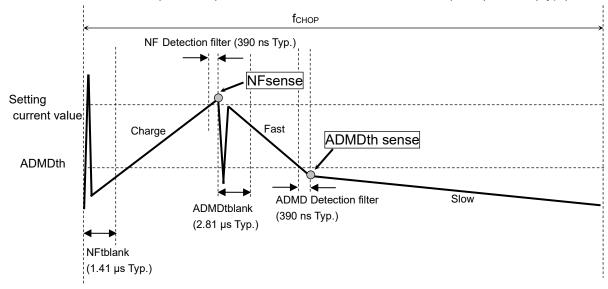


Figure 7.12.2 ADMD (Advanced Dynamic Mixed Decay) Constant current control 2

Note: The timing chart is simplified to explain functions and operations. Values in the timing chart are for reference only.



7.13. ADMD (Advanced Dynamic Mixed Decay) current waveform 1

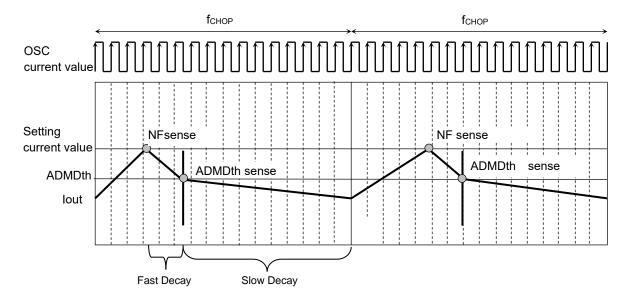


Figure 7.13 ADMD (Advanced Dynamic Mixed Decay) current waveform

Note: Timing charts are simplified to explain functions and operations.



7.14. ADMD (Advanced Dynamic Mixed Decay) current waveform 2

If the set current value is in the increasing direction

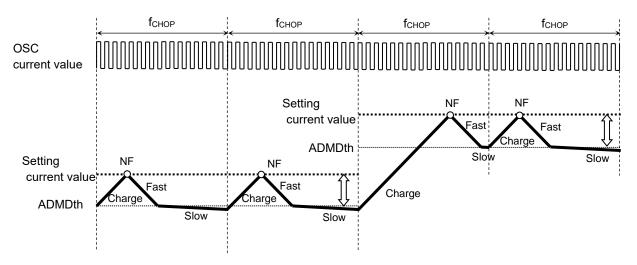


Figure 7.14.1 If the set current value is in the increasing direction

• Charge period is more than one fCHOP cycle

If the period of time (Charge period) until the motor current reaches the next set value (step), such as when switching the set current value (step), exceeds one cycle of the set chopping cycle (f_{CHOP}), Charge continues for the next f_{CHOP} cycle, and after reaching NF, the motor shifts to ADMD control.

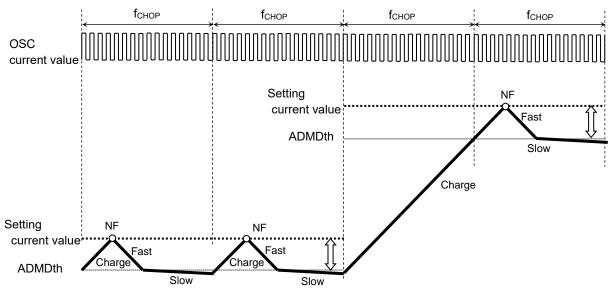


Figure 7.14.2 If the Charge period is more than one f_{CHOP} cycle

Note: Timing charts are simplified to explain functions and operations.



If the set current value is in the decreasing direction

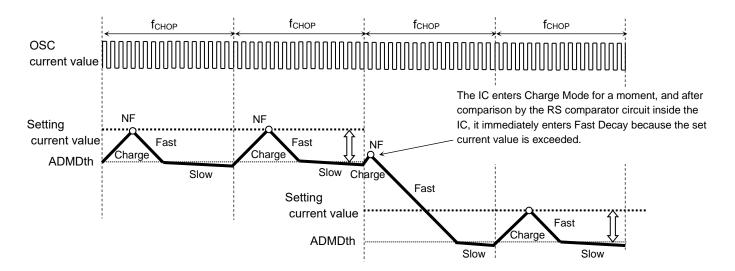


Figure 7.14.3 If the set current value is in the decreasing direction

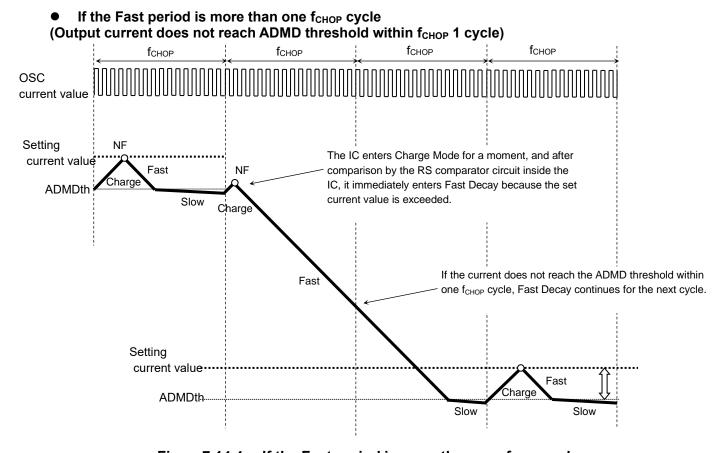


Figure 7.14.4 If the Fast period is more than one f_{CHOP} cycle

Note: Timing charts are simplified to illustrate functions and operations.



7.15. Function of RESET

The internal electric angle can be initialized.

Table7.15.1 Function of RESET

| RESET | Function |
|-------|-------------------------------|
| Н | Electric angle initialization |
| L | normal operation |

The current in each phase when RESET is applied is as follows.

Table 7.15.2 Each phase current when RESET is applied

| excitation mode | Phase A current | Phase B current | Initial electric angle |
|----------------------------------|-----------------|-----------------|------------------------|
| Full step resolution setting | 100 % | 100 % | 45 ° |
| Half step resolution (a) setting | 100 % | 100 % | 45 ° |
| Half step resolution (b) setting | 71 % | 71 % | 45 ° |
| Quarter step resolution setting | 71 % | 71 % | 45 ° |
| 1/8 step resolution setting | 71 % | 71 % | 45 ° |
| 1/16 step resolution setting | 71 % | 71 % | 45 ° |
| 1/32 step resolution setting | 71 % | 71 % | 45 ° |

7.16. Torque Function

This pin is used to set the torque of the motor.

Table7.16 Torque Function

| TRQ1 pin input | TRQ0 pin input | Function |
|----------------|----------------|-----------------------|
| L L | | Torque setting: 100 % |
| L H | | Torque setting: 75 % |
| Н | L | Torque setting: 50 % |
| Н | Н | Torque setting: 25 % |

7.17. Function of MO

Internal electrical angle can be checked by connecting the output of the MO pin to a potential of 3.3 V or 5 V with a 10 k \sim 100 k Ω pull-up resistor.

Table 7.17 Function of MO

| MO | Function |
|----------------|--|
| H (at pull-up) | Electric angle is other than the initial value |
| L | Initial value of electric angle |



7.18. LO (error detection flag output) Function

The LO function outputs an external signal when the error detection function is activated.

Since this is an open drain pin, when using the function, connect the LO1 and LO2 pin outputs to 3.3 V or 5 V potential with a 10 k Ω to 100 k Ω pull-up resistor.

In normal operation, the LO1 pin level is Hi-Z (internal MOSFET is OFF). If the error detection function (over-temperature (TSD), over-current (ISD), etc.) is activated, the pin level becomes Low (internal MOSFET is ON). If the LO pin is not used, leave it open. The LO2 pin goes Low only when a TSD is detected.

Table7.18.1 LO1 Function

| LO1 output pin Function | | | |
|-------------------------|--|--|--|
| H(at pull-up) | Normal state (normal operation) | | |
| L | Overcurrent detection (ISD), Thermal shutdown (TSD) status | | |

Table7.18.2 LO2 Function

| LO2 output pin | Function |
|----------------|---------------------------------|
| H(at pull-up) | Normal state (normal operation) |
| L | Thermal shutdown (TSD) status |

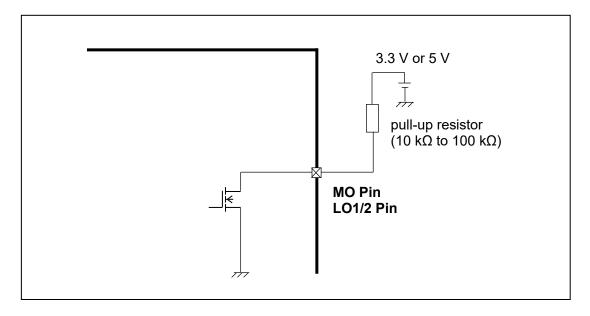
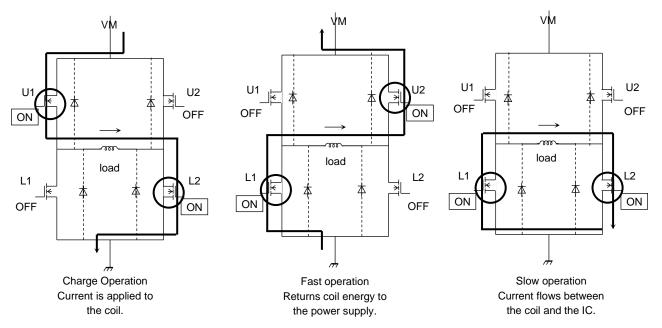


Figure 7.18 LO Function

Note: Equivalent circuits may be partially omitted or simplified to explain the circuit.



8. Output stage transistor operation mode (Advanced Dynamic Mixed Decay)



Output stage transistor operation mode (Advanced Dynamic Mixed Decay)

Note: When switching outputs, the IC has an internal time to prevent through-current.

8.1. Functions of output stage transistor operation

Table8.1.1 Function of output stage transistor operation 1

| Mode | U1 | U2 | L1 | L2 |
|--------|-----|-----|-----|-----|
| CHARGE | ON | OFF | OFF | ON |
| FAST | OFF | ON | ON | OFF |
| SLOW | OFF | OFF | ON | ON |

Note: The table above shows the case where the current flows in the direction of the arrow in the figure above as an example.

For the opposite direction, the table below is used.

Table8.1.2 Function of output stage transistor operation 2

| Mode | U1 | U2 | L1 | L2 |
|--------|-----|-----|-----|-----|
| CHARGE | OFF | ON | ON | OFF |
| FAST | ON | OFF | OFF | ON |
| SLOW | OFF | OFF | ON | ON |

Note: This IC automatically switches between the three modes shown in the above figure and performs constant-current control.

Equivalent circuits are partially omitted or simplified to explain the circuit.



9. About the set current value (I_{OUT})

The set current value during constant-current PWM control can be set by the reference voltage (V_{REF}) and RS resistance value.

The set current value (I_{OUT}) can be calculated by the following formula.

 $I_{OUT} = V_{REF} \times 0.833$ Example: If $V_{REF} = 3.6 \text{ V}$, $I_{OUT} = 3.0 \text{ A}$

10. About chopping frequency (fchop)

The chopping frequency of the constant current control of the motor current can be set by the resistor Rosc connected to the OSCM terminal. It is also possible to use a fixed value chopping frequency without any external components attached to the OSCM terminals.

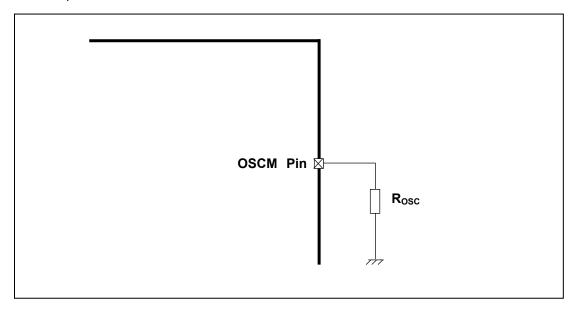


Figure 10 About chopping frequency (f_{CHOP})

Note: Equivalent circuits may be partially omitted or simplified to explain the circuit.

The chopping frequency (f_{CHOP}) can be calculated using the following formula. Generally, it is recommended that the frequency be set in the range of 40 kHz to 100 kHz with a reference frequency of about 70 kHz.

```
f_{CHOP} = f_{OSCM} / 16
f_{OSCM} = 1/(\alpha \times R_{OSC} + \beta) [MHz] \alpha = 1.7 \times 10^{-5}, \beta = 0.0285
Example: If Rosc=47 kΩ, foscm=1.2 MHz (Typ.), fchop=75 kHz (Typ.)
```

With the OSCM pin open or GND shorted, the frequency foscm2=914 kHz (Typ.) automatically generated inside the IC,f_{CHOP}=57.1 kHz (Typ.).



11. Power Consumption of IC

The power consumed by an IC can be roughly divided into two parts: the power consumed by the transistors in the output section and the power consumed by the logic section.

11.1. Power consumption of power transistor section

The power in the output section is consumed by the transistors above and below the H-bridge.

The power in the transistor section of an H-bridge can be expressed by the following equation

P (out) =
$$I_{out}(A) \times VDS(V) = I_{out}(A)^2 \times R_{on}(\Omega)$$
....(1)

The average power consumption of the output in the case of full step resolution setting and a perfect square waveform of the output current waveform can be calculated as follows

The average power consumption of the output can be calculated as follows.

$$R_{on}$$
 =0.4 Ω , I_{out} (peak : Max) = 1.0 A, V_{M} = 24 V then the following can be calculated. P (out) = 2 (Tr) \times 1.0 (A)^2 \times 0.4(Ω).....(2) = 0.8(W)

11.2. Power consumption of logic and IM systems

Then the calculation can be done as follows. The power consumption of the logic and IM system is calculated separately for operating and stopped conditions.

```
I(I_{M3}) = 7.5 \text{ mA (Typ.): operation/axis}
I(I_{M2}) = 4.8 \text{ mA (Typ.)}: stopped/axis
I(I_{M1}) = 0.03 \mu A(Typ.): standby/axis
```

The output system is connected to V_M (24 V). (Output system: Current consumed by the circuit connected to V_M and current consumed by the output stage when switching. switching).

Power consumption can be estimated as follows

$$P(I_{M3}) = 24 (V) \times 0.0075(A)$$
(3)
=0.18(W)

11.3. Power consumption

From the results of 1 and 2, the overall power consumption, P, can be calculated as follows

$$P = P (out) + P (I_{M3}) = 0.98 (W)$$

In addition, the power consumption for one axis in standby is as follows

P (standby) = 24 (V)
$$\times 0.03(\mu A) = 0.72(\mu W)$$

For the thermal design of the board, etc., please set with a margin after sufficient evaluation of the mounting.



12. About the detection function

The following detection functions are available

Table12 About the detection function

| Detection function | Detection location | Detection level | Action at detection | Method of recovery from detection state |
|---------------------------------|---------------------|---|------------------------|---|
| Overheat detection (TSD) | Chip temperature | 160 °C (Typ.) or higher 5.0 µs (Typ.) dead zone time | l • | This function is a latch type that maintains the operation at the time of detection. |
| Idelection | Output current | 4.5 A (Typ.) min. 1.25 μs (Typ.) dead zone time | All outputs forced OFF | It is restored by one of the following processes. Turn on the power again. Set the device to sleep mode and then set it to normal operation mode again. |
| Low supply voltage (UVLO) | VM Pin Voltage | 4.0 V (Typ.) or less With 1.41 µs (Typ.) dead zone time | | Increase VM voltage to 4.2 V (Typ.) or higher |

13. Overheat detection (This function is a latch type that maintains operation at the time of detection.)

This function temporarily stops IC operation when abnormal overheating of the device occurs. A dead-time period is set for overheat detection to prevent false detection due to external noise. When overheat is detected, all channels are turned off.

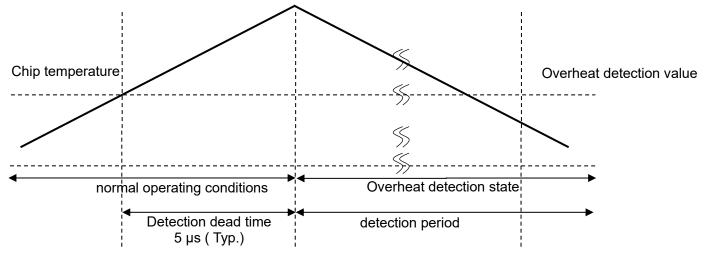


Figure 13 **Overheat Detection**

Note: The timing chart is simplified to explain functions and operations. Values in the timing chart are for reference only.



14. Overcurrent detection (This function is a latch type that maintains operation at the time of detection.)

This function temporarily stops IC operation in the event of a short between motor outputs, or a power/ground fault.

For overcurrent detection, a dead-time period is set to prevent false detection due to spike currents during switching or noise from external sources. When an overcurrent is detected, not only the corresponding channel but also both channels are turned off.

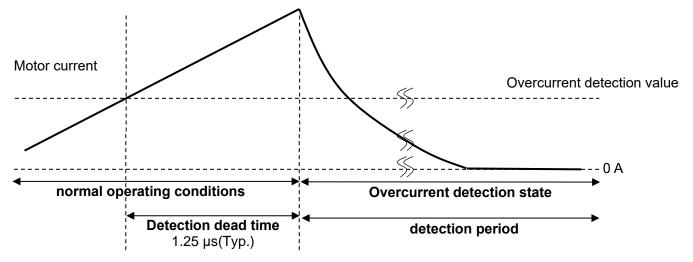


Figure 14 Overcurrent detection

Note: The timing chart is simplified to explain functions and operations. Values in the timing chart are for reference only.



15. Absolute Maximum Ratings (T_a = 25 °C)

Table15 Absolute Maximum Ratings

| Entry | Symbol | rated value | Uniti |
|-------------------------------|------------------|-------------|-------|
| Motor power supply voltage | V _M | 45 | V |
| Motor output voltage | Vouт | 50 | V |
| Motor output current (Note 1) | l _{OUT} | 3.0 | А |
| Internal regulator voltage | V _{CC} | 6.0 | V |
| Logic input pin voltage | V _{IN} | 6.0 | V |
| Vref reference voltage | V_{ref} | 6.0 | V |
| MO,LO Pin Voltage | V _{MO} | 6.0 | V |
| Power Dissipation(Note2) | P _D | 4.0 | W |
| Operating temperature | Topr | -40 to 85 | °C |
| Storage Temperature | T _{stg} | -55 to 150 | °C |
| Junction Temperature | $T_{j(MAX)}$ | 150 | °C |

Note 1: The maximum current value under normal conditions should be 2.7 A or less per equivalent after thermal calculation. Depending on the ambient temperature and board conditions, the current may be further limited due to heat generation conditions.

Note 2: JEDEC compliant 4-layer board mounting (Ta = 25 °C) If T_a exceeds 25 °C, derating at 32.0 mW/°C is required.

: The ambient temperature of the IC.

 T_{opr} : The ambient temperature of the IC at the time of operation.

: The chip temperature of the IC during operation. t_i maximum value is limited by the temperature of the TSD (thermal shutdown circuit).

It is recommended that the maximum value of T_i be designed considering the maximum current in use, which should be around 120 °C.

Absolute maximum ratings

Absolute maximum ratings are standards that must not be exceeded even momentarily.

Exceeding the absolute maximum ratings may cause destruction, degradation, or damage to the IC, or may cause destruction, damage, or degradation to other ICs.

Always design the product so that the absolute maximum ratings are not exceeded under any operating conditions.

In addition, this product is not equipped with an overvoltage detection circuit.

Therefore, the IC will be destroyed if an excessive voltage above the Spec is applied.

Please be sure to use each voltage range, including supply voltage, within the Spec.

Please also refer to the precautions section on the following page for more information on this precaution



16. PD-Ta graph (for reference)

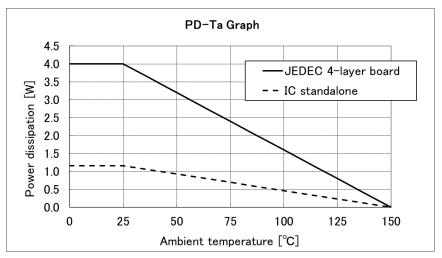


Figure16 PD-Ta graph

17. Operating range ($T_a = -40 \text{ to } 85 \text{ }^{\circ}\text{C}$)

Table17 Operating range

| Entry | Symbol | Min | Тур. | Max | Unit | Note |
|-------------------------------------|--------------------|------|------|-----|------|--------------------------|
| Motor power supply voltage (Note 1) | V _M | 8.2 | 24.0 | 44 | V | - |
| Motor output current | Іоит | = | - | 2.7 | Α | Equivalent to 1 (Note 2) |
| Logio input voltago | $V_{\text{IN(H)}}$ | 2.0 | 1 | 5.5 | V | H level of logic |
| Logic input voltage | $V_{\text{IN}(L)}$ | -0.5 | - | 0.8 | V | L level of logic |
| Chopping frequency | f _{CHOP} | 40 | 70 | 150 | kHz | - |
| Clock frequency | f_{CLK} | - | - | 250 | kHz | - |
| Vref reference voltage | V _{REF} | 0 | - | 3.6 | V | - |

Note 1: The slew rate from 0 V to 10 V at power-on should be 1 ms or more. If you intend to use the product under different conditions, please evaluate the customer's product alone and the system as a whole thoroughly and determine its applicability at your own risk.

Note 2: The maximum current that can actually be used may be limited by the operating environment (operating conditions such as excitation mode and operating time, ambient temperature conditions, and heat generation conditions such as board conditions). Please confirm the maximum current value that can actually be used after thermal calculation under the operating environment.



18. Electrical Specifications

18.1. Electrical Specifications 1($T_a = 25$ °C, $V_M = 24$ V unless otherwise specified)

Table18.1 Electrical Specifications 1

| Entry | | Symbol | Measuring conditions | Min | Тур. | Max | Unit |
|--|------------|--------------------------|---|------|------|------|------|
| Logic Input Pin | High | $V_{\text{IN(H)}}$ | Logic input terminal (Note) | 2.0 | - | 5.5 | V |
| Input Voltage | Low | $V_{\text{IN}(L)}$ | Logic input terminal (Note) | -0.5 | - | 8.0 | V |
| input hysteresis | | V _{IN(HYS)} | Logic system input terminal (Note) | - | 150 | - | mV |
| Logic Input Pin | High | I _{IN(H)} | Measurement Logic input terminal : 5 V | 35 | 50 | 75 | μA |
| Input current | Low | I _{IN(L)} | Measurement logic system input terminal: 0 V | - | - | 1 | μA |
| LO,MO pin output volta | age | $V_{OL(MO)}$ | IOL=5 mA, Output Low | - | 0.2 | 0.5 | V |
| Current Consumption | | I _{M1} | Output: Open, in sleep mode | - | 0.03 | 1 | μΑ |
| | | I _{M2} | Output : Open, SLEEP=H,ENABLE=L | - | 4.8 | 5.5 | mA |
| · | | I _{M3} | Output : Open (2-phase excitation), SLEEP=H, ENABLE=H Chopping frequency 40 kHz | - | 7.5 | 8.2 | mA |
| Motor output leakage | upper side | Іон | V _M = 44V, V _{OUT} = 0 V | - | - | 1 | μA |
| current | underside | loL | V _M = V _{OUT} = 44 V | 1 | - | - | μA |
| Output current channel-to-channel error | | Δl _{OUT1} | Output current error between channels I _{OUT} = 1.0 A | -5 | 0 | 5 | % |
| Output current setting error | | ΔI_{OUT2} | I _{OUT} = 1.0 A | -5 | 0 | 5 | % |
| Output Transistor Between drain and so On-resistance (sum of lower) | | Ron(d-s) | T _j = 25°C I _{OUT} = 2.0 A | - | 0.4 | 0.52 | Ω |

Note : V_{IN} voltage is defined as $V_{\text{IN}(H)}$ when V_{IN} is added to the measurement terminal and its voltage is increased from 0 V and the motor output terminal voltage changes. When the voltage is lowered and the motor output terminal voltage changes, the V_{IN} voltage is defined as $V_{IN(L)}$. Furthermore, the difference between $V_{\text{IN(H)}}$ and $V_{\text{IN(L)}}$ is defined as $V_{\text{IN(HYS)}}$.



18.2. Electrical Specifications 2 (T_a = 25 °C, V_M = 24 V unless otherwise specified)

Table 18.2 Electrical Characteristics 2

| Entry | Symbol | Measuring conditions | Min | Тур. | Max | Unit |
|---|------------------------|---------------------------|-----|-------|-----|------|
| Vref Input Current | I _{REF} | $V_{ref} = 3.6 \text{ V}$ | ı | 0 | 1 | μA |
| Vref Attenuation Ratio | V _{REF(GAIN)} | $V_{ref} = 2.0 \text{ V}$ | ı | 0.833 | ı | - |
| TSD Temperature | T _{jTSD} | - | 145 | 160 | 175 | °C |
| VM power-on reset voltage | V _{MPOR} | - | 3.8 | 4.0 | 4.2 | V |
| VM power-on reset hysteresis | V _{MPOR(HYS)} | - | - | 200 | - | mV |
| Overcurrent detection circuit operating current | I _{SD} | - | 3.1 | 4.5 | 5.8 | А |

18.2.1. With respect to back EMF

Power regeneration timing occurs while the motor is running, at which time the motor current is regenerated to the power supply due to the back EMF of the motor.

If the power supply does not have Sink capability, the power supply and output terminals of the IC may rise above their ratings.

Since the back EMF of the motor varies depending on the conditions of use and the characteristics of the motor, please make sure that the back EMF does not destroy the IC, that there are no problems with its operation, and that there is no malfunction or destruction of the peripheral circuits, etc.

18.2.2. Overcurrent and overheat detection

These detection functions are intended to temporarily avoid abnormal conditions such as output short circuits, and are not intended to guarantee that the IC will not be destroyed.

The detection function does not work outside the guaranteed operating range, and a short-circuit may destroy the IC.

The overcurrent detection function is intended to detect temporary short circuits. If the short-circuit continues for a long period of time, the IC may be destroyed due to overstress. The system should be configured to release the overcurrent condition as soon as possible.

18.2.3. Handling of ICs

Do not incorrectly install the device, including rotating it, as this may cause destruction, damage, or deterioration to the IC or device.



19. AC electrical characteristics (T_a = 25 °C, V_M = 24V)

Table19 AC electrical characteristics

| Entry | Symbol | Measuring conditions | Min | Тур. | Max | Unit |
|---|-----------------------|---------------------------------------|------|------|------|------|
| Minimum clock pulse width | t _{CLK(H)} | - | 600 | - | - | ns |
| | t _{CLK(L)} | - | 600 | - | ı | ns |
| Logic Input Signal Minimum Pulse Width 1 | t _{RS(H)} | RESET, SLEEP_X, DECAY | 1.5 | - | 1 | μs |
| | $t_{\text{RS}(L)}$ | RESET, SLEEP_X, DECAY | 1.5 | - | - | μs |
| Logic input signal minimum pulse width 2 | t _{DTE(H)} | TRQ0/1, ENABLE | 600 | ı | ı | ns |
| | $t_{DTE(L)}$ | TRQ0/1、ENABLE | 600 | | - | ns |
| Setup time | tsu(STEP) | CW_CCW、DMODE0/1/2 | 600 | - | ı | ns |
| Hold time | t _{H(STEP)} | CW_CCW、DMODE0/1/2 | 600 | ı | ı | ns |
| Output Transistor Switching characteristics | tr | - | 40 | 70 | 100 | ns |
| | t _f | - | 50 | 80 | 110 | ns |
| | $t_{\text{pLH(CLK)}}$ | - | ı | 1000 | ı | ns |
| | $t_{\text{pHL(CLK)}}$ | - | ı | 1000 | ı | ns |
| OSCM oscillation frequency | foscm1 | Rosc=47 kΩ | 1020 | 1200 | 1380 | kHz |
| | foscm2 | When OSCM pin is open or GND is short | 777 | 914 | 1051 | |
| chopping frequency | fchop | foscм = 1200 kHz | - | 75 | - | kHz |



20. AC Characteristics Timing Chart

TB67S589FNG(Relationship between CLK and output)

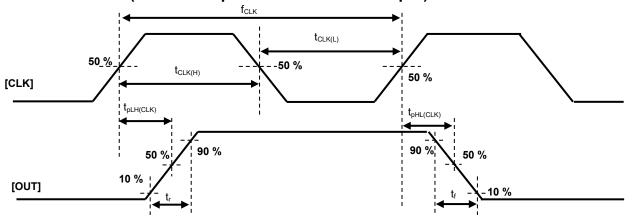


Figure 20.1 TB67S589FNG(Relationship between CLK and output)

Note: The timing chart is simplified to explain the function and operation.

TB67S589FNG(Relationship between CLK and other control signals)

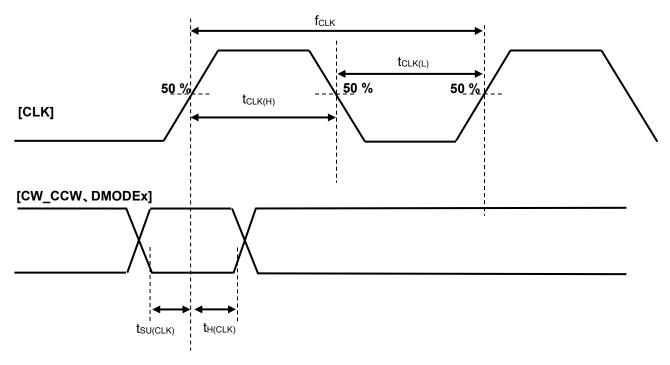


Figure 20.2 TB67S589FNG (Relationship between CLK and other control signals)

Note: The timing chart is simplified to explain the function and operation.



21. Application Circuit Example

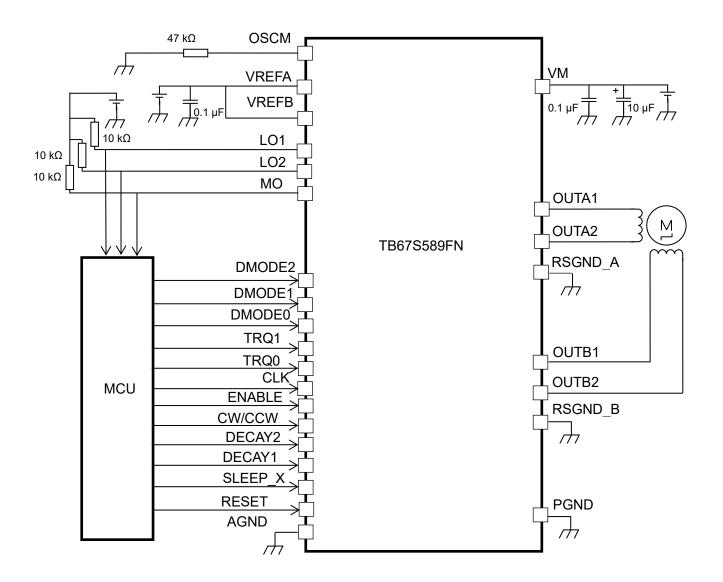


Figure21 Application Circuit Example

It is recommended that the heat dissipation pads (at the four corners and the center) on the backside of the package be connected to the GND of the board to improve heat dissipation.

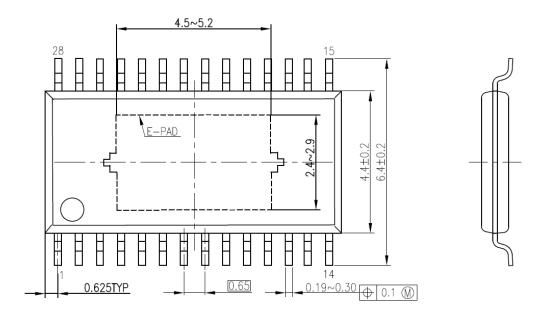
Note: Some application circuit examples may be omitted or simplified in order to explain the circuit.

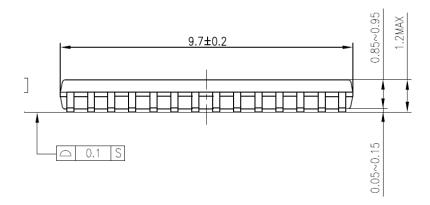


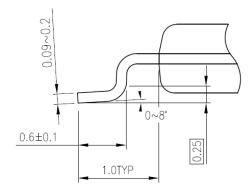
22. Package Information

P-HTSSOP28-0510-0.65-001

Unit: mm







Package Dimensions Figure22

Weight: 0.106 g (Typ.)



23. Notes on Contents

Block Diagrams

Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purposes.

Timing Charts

Timing charts may be simplified for explanatory purposes.

Application Circuits

The application circuits shown in this document are provided for reference purposes only. Thorough evaluation is required, especially at the mass production design stage. Providing these application circuit examples does not grant a license for industrial property rights.

24. IC Usage Considerations

24.1. Notes on Handling of ICs

- (1) The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings. Exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion.
- (2) Use an appropriate power supply fuse to ensure that a large current does not continuously flow in case of over current and/or IC failure. The IC will fully break down when used under conditions that exceed its absolute maximum ratings, when the wiring is routed improperly or when an abnormal pulse noise occurs from the wiring or load, causing a large current to continuously flow and the breakdown can lead smoke or ignition. To minimize the effects of the flow of a large current in case of breakdown, appropriate settings, such as fuse capacity, fusing time and insertion circuit location, are required.
- (3) If your design includes an inductive load such as a motor coil, incorporate a protection circuit into the design to prevent device malfunction or breakdown caused by the current resulting from the inrush current at power ON or the negative current resulting from the back electromotive force at power OFF. IC breakdown may cause injury, smoke or ignition. Use a stable power supply with ICs with built-in protection functions. If the power supply is unstable, the protection function may not operate, causing IC breakdown. IC breakdown may cause injury, smoke or ignition.
- (4) Do not insert devices in the wrong orientation or incorrectly. Make sure that the positive and negative terminals of power supplies are connected properly. Otherwise, the current or power consumption may exceed the absolute maximum rating, and exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion. In addition, do not use any device that is applied the current with inserting in the wrong orientation or incorrectly even just one time.
- (5) Carefully select external components (such as inputs and negative feedback capacitors) and load components (such as speakers), for example, power amp and regulator. If there is a large amount of leakage current such as from input or negative feedback condenser, the IC output DC voltage will increase. If this output voltage is connected to a speaker with low input withstand voltage, overcurrent or IC failure may cause smoke or ignition. (The overcurrent may cause smoke or ignition from the IC itself.) In particular, please pay attention when using a Bridge Tied Load (BTL) connection-type IC that inputs output DC voltage to a speaker directly.



24.2. Points to Remember on Handling of ICs

(1) Over current Protection Circuit

Over current protection circuits (referred to as current limiter circuits) do not necessarily protect ICs under all circumstances. If the Over current protection circuits operate against the over current, clear the over current status immediately.

Depending on the method of use and usage conditions, such as exceeding absolute maximum ratings can cause the over current protection circuit to not operate properly or IC breakdown before operation. In addition, depending on the method of use and usage conditions, if over current continues to flow for a long time after operation, the IC may generate heat resulting in breakdown.

(2) Thermal Shutdown Circuit

Thermal shutdown circuits do not necessarily protect ICs under all circumstances. If the thermal shutdown circuits operate against the over temperature, clear the heat generation status immediately. Depending on the method of use and usage conditions, such as exceeding absolute maximum ratings can cause the thermal shutdown circuit to not operate properly or IC breakdown before operation.

(3) Heat Radiation Design

In using an IC with large current flow such as power amp, regulator or driver, please design the device so that heat is appropriately radiated, not to exceed the specified junction temperature (Tj) at any time and condition. These ICs generate heat even during normal use. An inadequate IC heat radiation design can lead to decrease in IC life, deterioration of IC characteristics or IC breakdown. In addition, please design the device taking into considerate the effect of IC heat radiation with peripheral components.

(4) Back-EMF

When a motor reverses the rotation direction, stops or slows down abruptly, a current flow back to the motor's power supply due to the effect of back-EMF. If the current sink capability of the power supply is small, the device's motor power supply and output pins might be exposed to conditions beyond absolute maximum ratings. To avoid this problem, take the effect of back-EMF into consideration in system design.



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